





<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
<b>INPUT</b>				
IRED continuous forward current		$I_F$	50	mA
IRED reverse voltage		$V_R$	5	V
Input power dissipation		$P_{diss}$	80	mW
<b>OUTPUT</b>				
DC or peak AC load voltage		$V_L$	250	V
Continuous load current (AC/DC configuration)		$I_L$	200	mA
Continuous load current (DC only configuration)		$I_L$	370	mA
SSR output power dissipation (continuous)		$P_{diss}$	550	mW
<b>SSR</b>				
Ambient temperature range		$T_{amb}$	-40 to +100	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	-40 to +150	$^{\circ}\text{C}$
Soldering temperature	$t = 10\text{ s max.}$	$T_{sld}$	260	$^{\circ}\text{C}$

**Note**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

<b>ELECTRICAL CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT</b>						
IRED forward current, switch turn-on	$I_L = 100\text{ mA}$ , $t = 10\text{ ms}$	$I_{Fon}$	-	0.4	2	mA
IRED forward current, switch turn-off	$V_L = \pm 200\text{ V}$	$I_{Foff}$	0.05	0.35	-	mA
IRED forward voltage	$I_F = 10\text{ mA}$	$V_F$	-	1.36	1.5	V
IRED reverse current	$V_R = 5\text{ V}$	$I_R$	-	-	10	$\mu\text{A}$
<b>OUTPUT</b>						
On-resistance (AC/DC configuration)	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$R_{ON}$	-	12	15	$\Omega$
On-resistance (DC only configuration)	$I_F = 5\text{ mA}$ , $I_L = 100\text{ mA}$	$R_{ON}$	-	3.2	3.6	$\Omega$
Off-resistance	$I_F = 0\text{ mA}$ , $V_L = \pm 100\text{ V}$	$R_{OFF}$	1	5000	-	$\text{G}\Omega$
Off-state leakage current	$I_F = 0\text{ mA}$ , $V_L = \pm 100\text{ V}$	$I_O$	-	< 1	100	nA
	$I_F = 0\text{ mA}$ , $V_L = \pm 200\text{ V}$	$I_O$	-	< 1	500	nA
Output capacitance (AC/DC configuration)	$I_F = 0\text{ mA}$ , $V_L = 1\text{ V}$ , 1 MHz	$C_O$	-	39	-	pF
	$I_F = 0\text{ mA}$ , $V_L = 50\text{ V}$ , 1 MHz	$C_O$	-	6	-	pF
Current limit (AC/DC configuration)	$I_F = 5\text{ mA}$ , $t = 5\text{ ms}$ , $V_L = \pm 6\text{ V}$	$I_{limit}$	300	440	550	mA
Current limit (DC only configuration)	$I_F = 5\text{ mA}$ , $t = 5\text{ ms}$ , $V_L = \pm 6\text{ V}$	$I_{limit}$	600	870	1100	mA
<b>TRANSFER</b>						
Capacitance (input to output)	$V_{IO} = 1\text{ V}$	$C_{IO}$	-	0.4	-	pF

**Note**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluations. Typical values are for information only and are not part of the testing requirements.

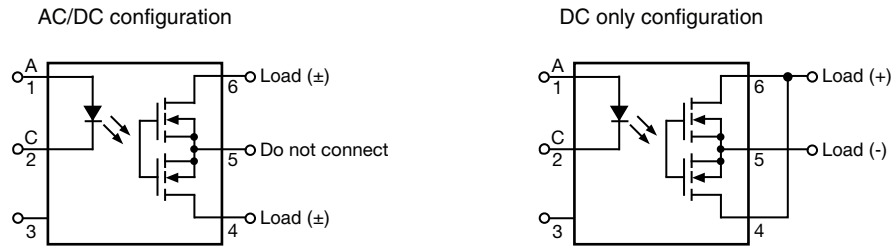
**PIN CONFIGURATION**


Fig. 1 - Pin Configuration

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{on}$	-	0.20	0.5	ms
Turn-off time	$I_F = 5\text{ mA}$ , $I_L = 50\text{ mA}$	$t_{off}$	-	0.03	0.2	ms

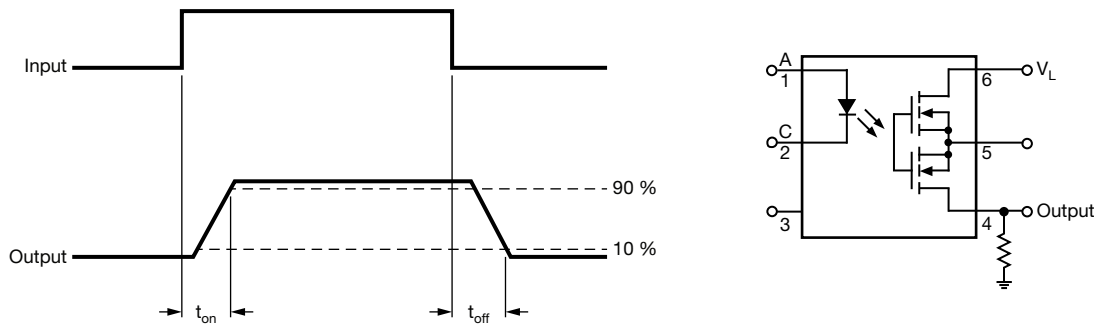


Fig. 2 - Timing Schematic

<b>SAFETY AND INSULATION RATINGS</b>				
PARAMETER	CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		40 / 100 / 21	
Pollution degree	According to DIN VDE 0109		2	
Comparative tracking index	Insulation group IIIa	CTI	175	
Maximum rated withstanding isolation voltage	According to UL1577, $t = 1\text{ min}$	$V_{ISO}$	5300	$V_{RMS}$
Maximum transient isolation voltage	According to DIN EN 60747-5-5	$V_{IOTM}$	8000	$V_{peak}$
Maximum repetitive peak isolation voltage	According to DIN EN 60747-5-5	$V_{IORM}$	890	$V_{peak}$
Insulation resistance	$V_{IO} = 500\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{12}$	$\Omega$
	$V_{IO} = 500\text{ V}$ , $T_{amb} = 100\text{ }^{\circ}\text{C}$	$R_{IO}$	$\geq 10^{11}$	$\Omega$
Output safety power		$P_{SO}$	720	mW
Input safety current		$I_{SI}$	240	mA
Safety temperature		$T_S$	175	$^{\circ}\text{C}$
Creepage distance	DIP-6		$\geq 7$	mm
Clearance distance			$\geq 7$	mm
Creepage distance	SMD-6		$\geq 8$	mm
Clearance distance			$\geq 8$	mm
Insulation thickness		DTI	$\geq 0.4$	mm
Input to output test voltage, method B	$V_{IORM} \times 1.875 = V_{PR}$ , 100 % production test with $t_M = 1\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1669	$V_{peak}$
Input to output test voltage, method A	$V_{IORM} \times 1.6 = V_{PR}$ , 100 % sample test with $t_M = 10\text{ s}$ , partial discharge $< 5\text{ pC}$	$V_{PR}$	1424	$V_{peak}$

**Note**

- As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.

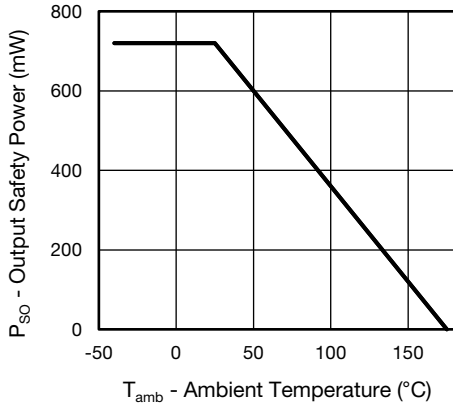


Fig. 3 - Output Safety Power vs. Ambient Temperature

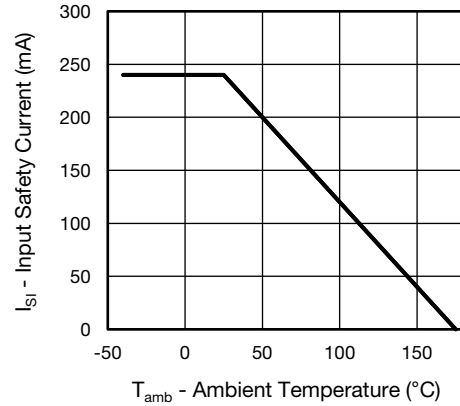


Fig. 4 - Input Safety Current vs. Ambient Temperature

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

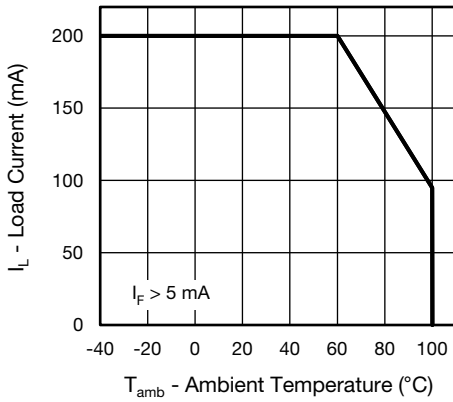


Fig. 5 - Load Current vs. Ambient Temperature

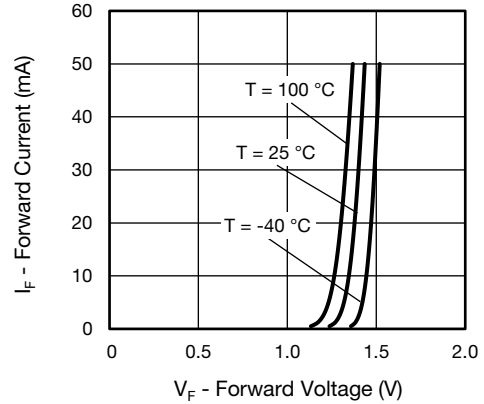


Fig. 7 - Forward Current vs. Forward Voltage

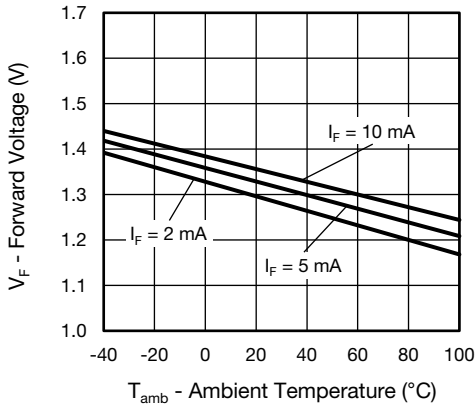


Fig. 6 - Forward Voltage vs. Ambient Temperature

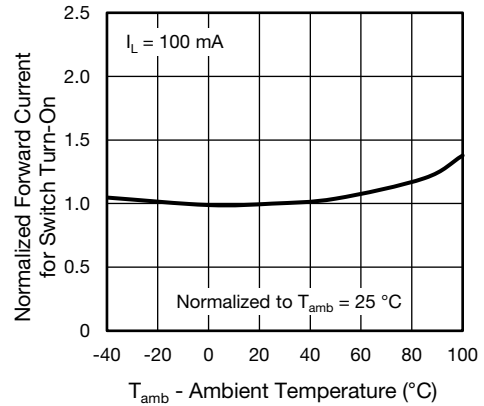


Fig. 8 - Normalized Forward Current for Switch Turn-On vs. Ambient Temperature

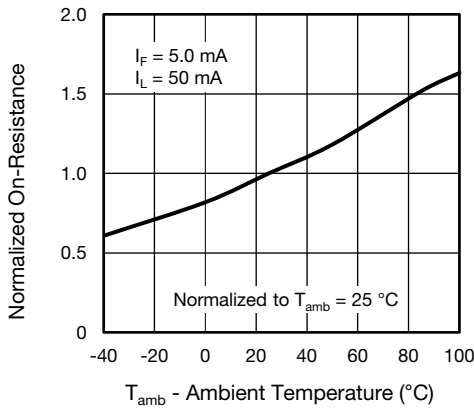


Fig. 9 - Normalized On-Resistance vs. Ambient Temperature

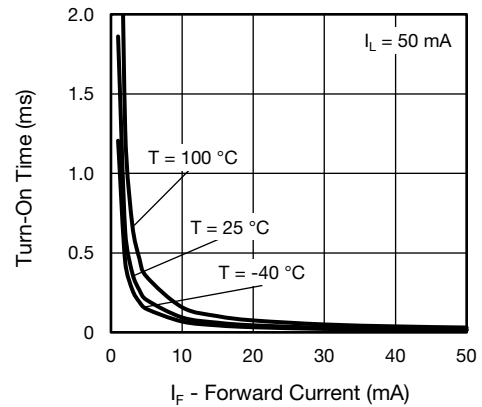


Fig. 12 - Turn-On Time vs. Forward Current

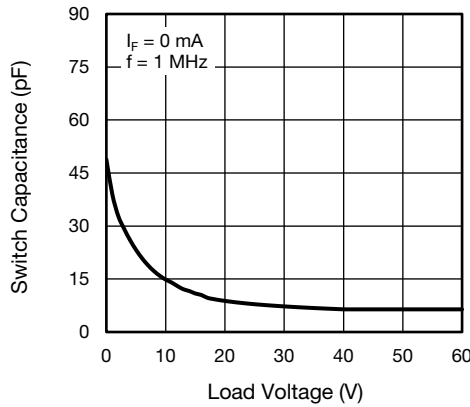


Fig. 10 - Switch Capacitance vs. Load Voltage

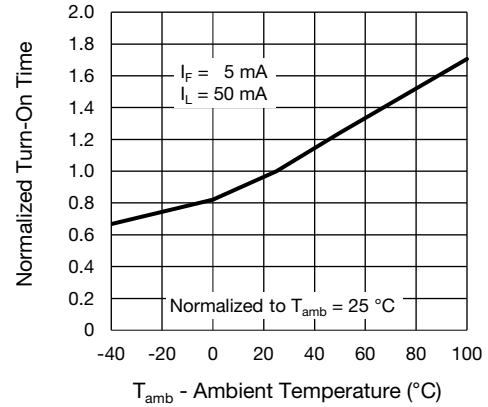


Fig. 13 - Normalized Turn-On Time vs. Ambient Temperature

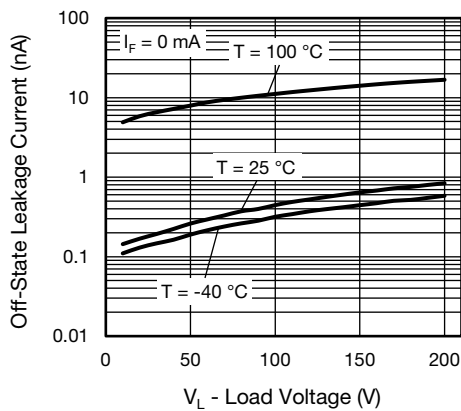


Fig. 11 - Off-State Leakage Current vs. Load Voltage

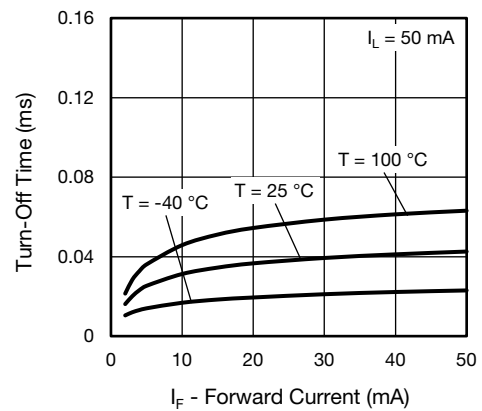


Fig. 14 - Turn-Off Time vs. Forward Current

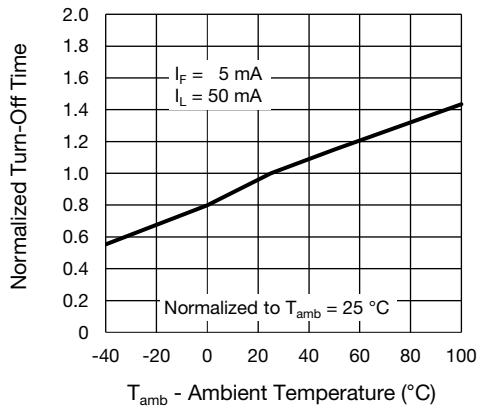


Fig. 15 - Normalized Turn-Off Time vs. Ambient Temperature

**PACKAGE DIMENSIONS** (in millimeters)

**SMD-6**

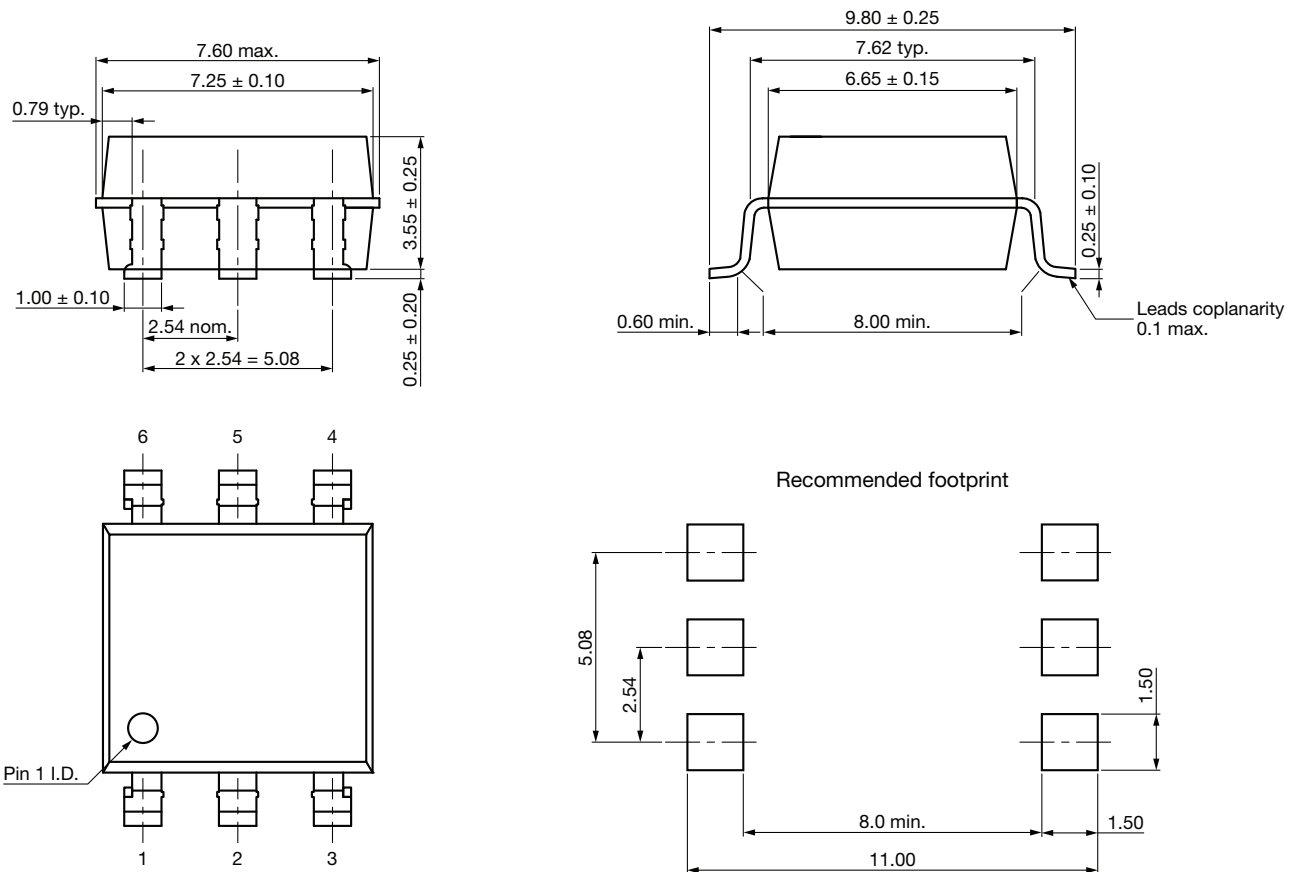


Fig. 16 - Package Drawings



## DIP-6

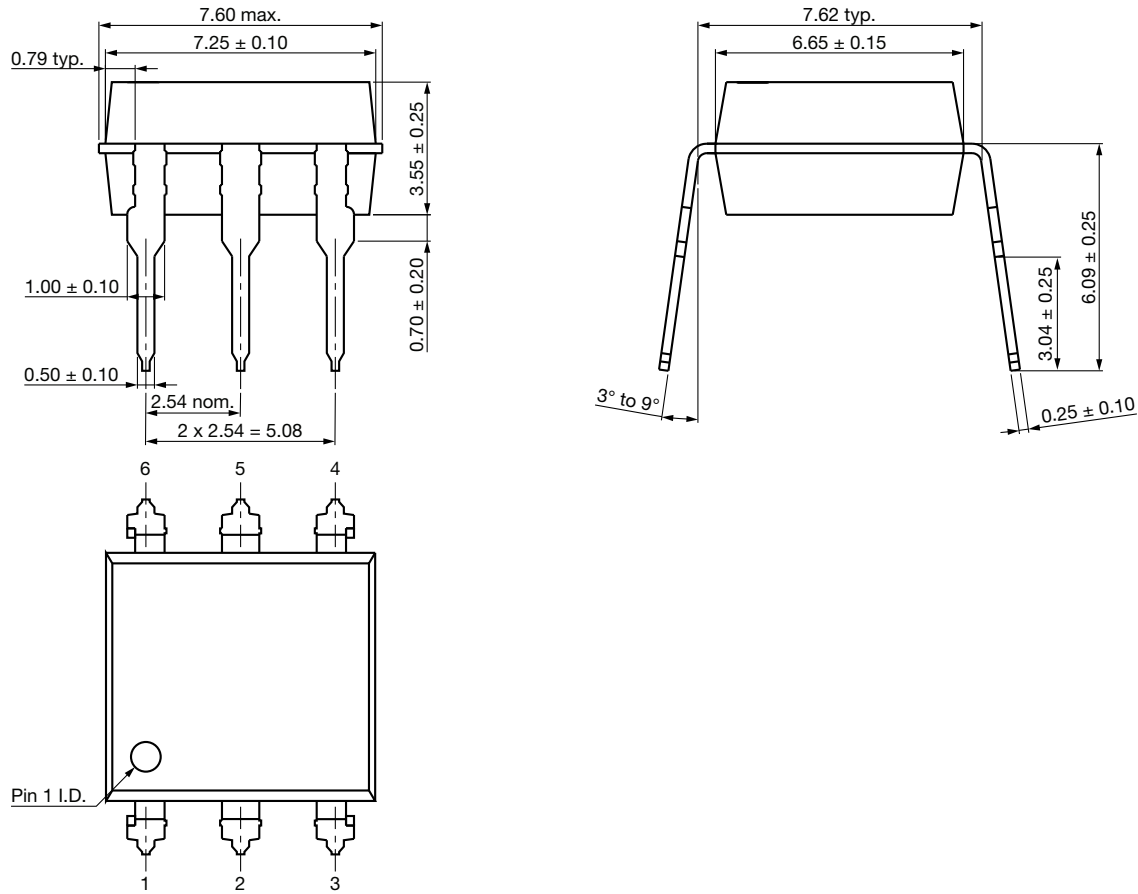


Fig. 17 - Package Drawings

## PACKAGE MARKING

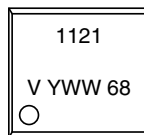


Fig. 18 - VOR1121

### Note

- Package configuration (T, A, B) are not part of the package marking.

**PACKING INFORMATION** (in millimeters)

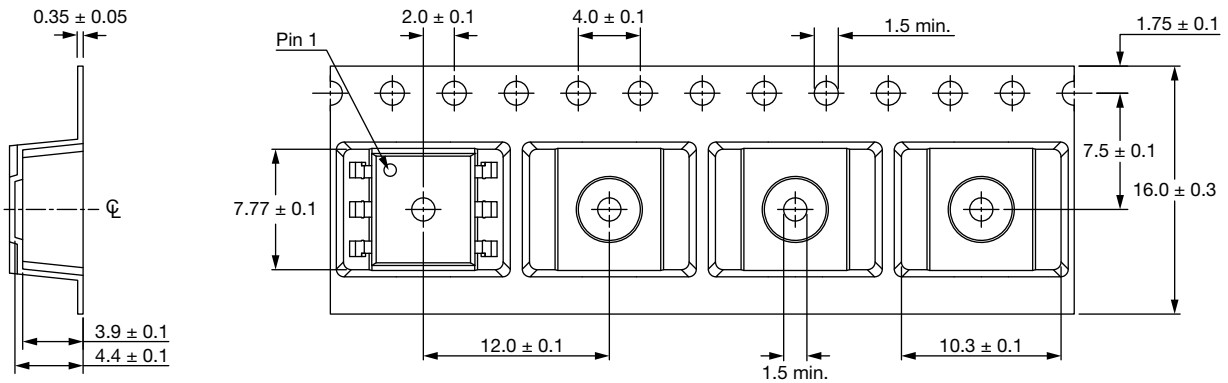


Fig. 19 - Tape and Reel Packing

TAPE AND REEL PACKING	
TYPE	UNITS/REEL
SMD-6	1000

TUBE PACKING			
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX
SMD-6	50	40	2000
DIP-6	50	40	2000

**SOLDER PROFILES**

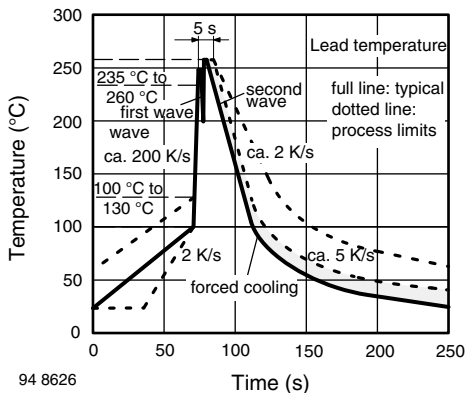


Fig. 20 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP Devices

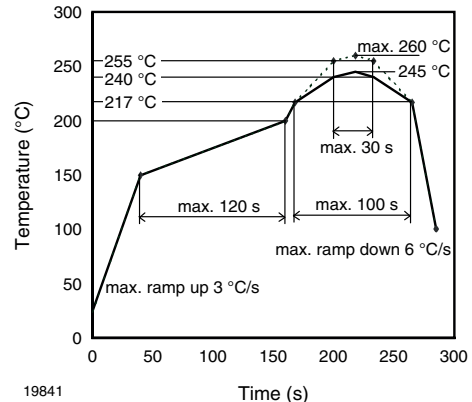


Fig. 21 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

**HANDLING AND STORAGE CONDITIONS**

ESD level: HBM class 2

Floor life: unlimited

Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ , RH < 85 %

Moisture sensitivity level 1, according to J-STD-020





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